# HIGH-SIDE CURRENT MONITOR

## DESCRIPTION

The ZXCT1009 is a high side current sense monitor. Using this device eliminates the need to disrupt the ground plane when sensing a load current.

It takes a high side voltage developed across a current shunt resistor and translates it into a proportional output current.

A user defined output resistor scales the output current into a ground-referenced voltage.

The wide input voltage range of 20V down to as low as 2.5V make it suitable for a range of applications. A minimum operating current of just 4µA, combined with its SOT23 package make it a unique solution, suitable for portable battery equipment.

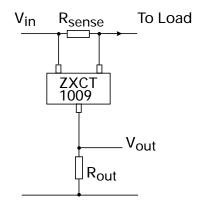
#### **FEATURES**

- Low cost, accurate high-side current sensing.
- Output voltage scaling.
- Up to 2.5V sense voltage.
- 2.5V 20V supply range.
- 4µA quiescent current.
- 1% typical accuracy.
- SOT23 & SM8<sup>†</sup> packages.

#### APPLICATIONS

- · Battery Chargers
- · Smart Battery Packs
- DC Motor control
- · Over current monitor
- Power Management
- Level translating
- · Programmable current source

## APPLICATION CIRCUIT



## ORDERING INFORMATION

PART NUMBER	PACKAGE	PARTMARKING		
ZXCT1009F	SOT23	109		
ZXCT1009T8	SM8	ZXCT1009		

SM8 due for release May 2001

Sampling April 2001

† 8 leaded SOT223



# **ABSOLUTE MAXIMUM RATINGS**

Voltage on any pin -0.6V to 20V (relative to lout)

Continuous output current 25mA

Continuous sense voltage  $V_{in} + 0.5V > V_{sense}^{\dagger} > V_{in} - 5V$ 

Operating Temperature  $-40 \text{ to } 85^{\circ}\text{C}$ Storage Temperature  $-55 \text{ to } 125^{\circ}\text{C}$ Package Power Dissipation  $(T_A = 25^{\circ}\text{C})$ SOT23 450mWSM8 2W

# **ELECTRICAL CHARACTERISTICS**

Test Conditions  $T_A$  = 25° C,  $V_{in}$  = 5V,  $R_{out}$  = 100 $\Omega$ 

SYMBOL	PARAMETER	CONDITIONS	LIMITS			UNIT
			Min	Тур	Max	
V <sub>in</sub>	V <sub>CC</sub> Range		2.5		20	V
I <sub>out</sub> 1	Output current	V <sub>sense</sub> =0V	1	4	15	μΑ
		V <sub>sense</sub> =10mV	90	104	120	μΑ
		V <sub>sense</sub> =100mV	0.975	1.002	1.025	mA
		V <sub>sense</sub> =200mV	1.95	2.0	2.05	mA
		V <sub>sense</sub> =1V	9.6	9.98	10.2	mA
V <sub>sense</sub> †	Sense Voltage		0		2500	mV
I <sub>sense</sub>	Load pin				100	nA
	input current					
Acc	Accuracy	$R_{sense} = 0.1\Omega$				
		V <sub>sense</sub> =200mV	-2.5		2.5	%
Gm	Transconductance,			10000		μ <b>A</b> /V
	I <sub>out</sub> / V <sub>sense</sub>					
BW	Bandwidth	RF P <sub>in</sub> = -20dBm‡ V <sub>sense</sub> = 10mV dc		300		kHz
		V <sub>sense</sub> = 100mV dc		2		MHz

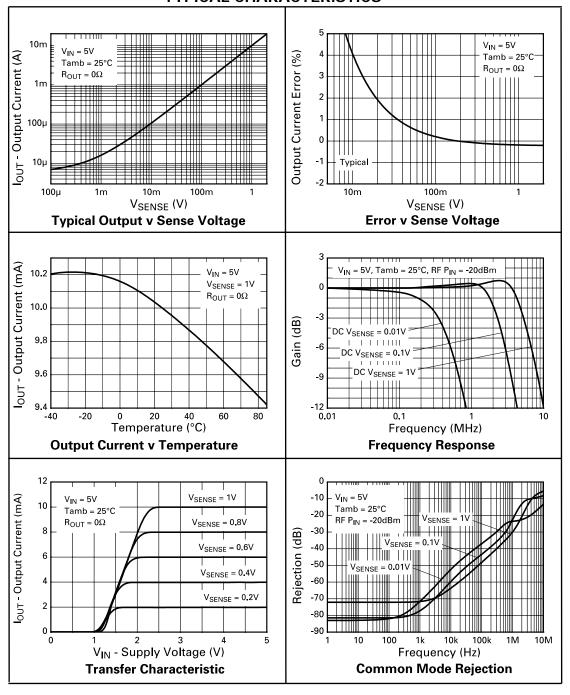
<sup>&</sup>lt;sup>1</sup> Includes input offset voltage contribution



<sup>&</sup>lt;sup>†</sup>V<sub>sense</sub>=V<sub>in</sub>-V<sub>load</sub>

 $<sup>\</sup>ddagger$  -20dBm=63mVp-p into  $50\Omega$ 

# TYPICAL CHARACTERISTICS

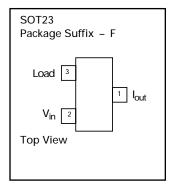


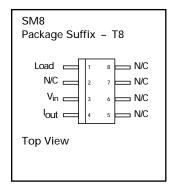


# PIN DESCRIPTION

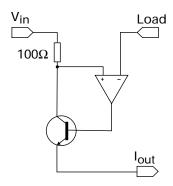
Pin Name	Pin Function			
V <sub>in</sub>	Supply Voltage			
Load	Connection to load/battery			
I <sub>out</sub>	Output current, proportional to V <sub>in</sub> -V <sub>load</sub>			

## CONNECTION DIAGRAMS





# **SCHEMATIC DIAGRAM**





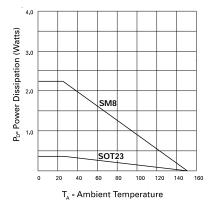
#### POWER DISSIPATION

The maximum allowable power dissipation of the device for normal operation (Pmax), is a function of the package junction to ambient thermal resistance ( $\theta$ ja), maximum junction temperature (Tjmax), and ambient temperature (Tamb), according to the expression:

$$P_{max} = (Tj_{max} - T_{amb}) / \theta_{ja}$$

The device power dissipation,  $P_{\text{D}}$  is given by the expression:

P<sub>D</sub>=I<sub>out</sub>.(V<sub>in</sub>-V<sub>out</sub>) Watts



## APPLICATIONS INFORMATION

The following lines describe how to scale a load current to an output voltage.

V<sub>sense</sub> = V<sub>in</sub> - V<sub>load</sub>

$$V_{out} = 0.01 \text{ x V}_{sense} \text{ x R}_{out}^{1}$$

E.g.

A 1A current is to be represented by a 100mV output voltage:

1)Choose the value of R<sub>sense</sub> to give 50mV > V<sub>sense</sub> > 500mV at full load.

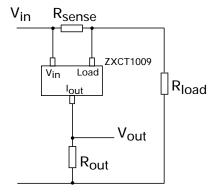
For example  $V_{sense} = 100 \text{mV}$  at 1.0A.  $R_{sense} = 0.1/1.0 => 0.1 \text{ ohms}$ .

2)Choose  $R_{out}$  to give  $V_{out}$  = 100mV, when  $V_{sense}$  = 100mV.

Rearranging  $^{1}$  for R<sub>out</sub> gives: R<sub>out</sub> = V<sub>out</sub> /(V<sub>sense</sub> x 0.01)

 $R_{out} = 0.1 / (0.1 \times 0.01) = 100 \Omega$ 

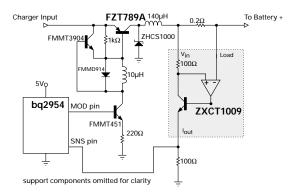
## TYPICAL CIRCUIT APPLICATION



Where  $R_{load}$  represents any load including DC motors, a charging battery or further circuitry that requires monitoring,  $R_{sense}$  can be selected on specific requirements of accuracy, size and power rating.



# APPLICATIONS INFORMATION (Continued)



# Li-Ion Charger Circuit

The above figure shows the ZXCT1009 supporting the Benchmarq bq2954 Charge Management IC. Most of the support components for the bq2954 are omitted for clarity. This design also uses the Zetex FZT789A high current Super- $\beta$  PNP as the switching transistor in the DC-DC step down converter and the FMMT451 as the drive NPN for the FZT789A. The circuit can be configured to charge up to four Li-lon cells at a charge current of 1.25A. Charge can be terminated on maximum voltage, selectable minimum current, or maximum time out. Switching frequency of the PWM loop is approximately 120kHz.

The ZXCT1009 is intended as a direct functional replacement for the ZDS1009, which is featured in a complete design from Unitrode/Texas Instruments on the Li-Ion charger circuit shown above. Reference: DVS2954S1H Li-Ion Charger Development System.

# **Transient Protection**

An additional resistor, Rlim can be added in series with Rout (figure 1.0), to limit the current from l<sub>out</sub>. Any circuit connected to Vout will be protected from input voltage transients. This can be of particular use in automotive applications where load dump and other common transients need to be considered.

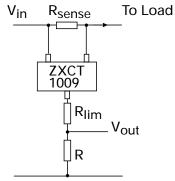


Figure 1.0 ZXCT1009 with additional current limiting Resistor Rlim.

Assuming the worst case condition of  $V_{out} = 0V$ ; providing a low impedance to a transient, the minimum value of  $R_{lim}$  is given by:-

$$R_{lim}(min) = \frac{V_{pk} - V_{max}}{I_{pk}}$$

V<sub>pk</sub> = Peak transient voltage to be withstood

 $V_{max}$  = Maximum working Voltage = 20V  $I_{Dk}$  = Peak output current = 40mA

Γ.

The maximum value of  $R_{lim}$  is set by  $V_{in}(min)$ ,  $V_{out}(max)$  and the dropout voltage (see transfer characteristic on page 3) of the ZXCT1009:-

$$R_{lim}(max) = \frac{R_{out}[V_{ln}(min) - (V_{dp} + V_{out}(max))]}{V_{out}(max)}$$

V<sub>in</sub>(min) = Minimum Supply Operating Voltage

V<sub>dp</sub> =Dropout Voltage

V<sub>out</sub> (max)= Maximum Operating Output Voltage

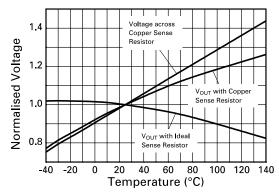


# **APPLICATIONS INFORMATION (Continued)**

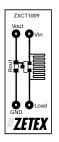
# PCB trace shunt resistor for low cost solution.

The figure below shows output characteristics of the device when using a PCB resistive trace for a low cost solution in replacement for a conventional shunt resistor. The graph shows the linear rise in voltage across the resistor due to the PTC of the material and demonstrates how this rise in resistance value over temperature compensates for the NTC of the device.

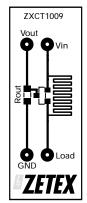
The figure opposite shows a PCB layout suggestion. The resistor section is 25mm x 0.25mm giving approximately  $150m\Omega$  using 1oz copper. The data for the normalised graph was obtained using a 1A load current and a  $100\Omega$  output resistor. An electronic version of the PCB layout is available at www.zetex.com/isense



Effect of Sense Resistor Material on Temperature Performance



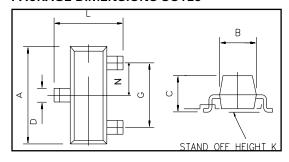
Actual Size



Layout shows area of shunt resistor compared to SOT23 package. Not actual size

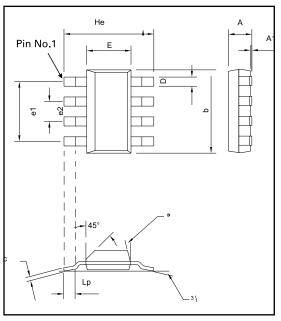


# PACKAGE DIMENSIONS SOT23



DIM	Millimetres		Inches		
	Min	Max	Min	Max	
Α	2.67	3.05	0.105	0.120	
В	1.20	1.40	0.047	0.055	
С	_	1.10	_	0.043	
D	0.37	0.53	0.0145	0.021	
F	0.085	0.15	0.0033	0.0059	
G	NOM 1.9		NOM 0.075		
К	0.01	0.10	0.0004	0.004	
L	2.10	2.50	0.0825	0.0985	
N	NOM 0.95		NOM 0.037		

# PACKAGE DIMENSIONS SM8



DIM	Millimetres			Inches		
	Min	Тур	Max	Min	Тур	Max
А	-	-	1.7	-	-	0.067
A1	0.02	-	0.1	0.0008	-	0.004
b	-	0.7	-	-	0.028	-
С	0.24	-	0.32	0.009	-	0.013
D	6.3	-	6.7	0.248	-	0.264
E	3.3	-	3.7	0.130	-	0.145
e1	-	4.59	_	_	0.180	_
e2	-	1.53	-	-	0.060	-
Не	6.7	-	7.3	0.264	-	0.287
Lp	0.9	-	-	0.035	-	-
α	_	-	15°	_	-	15°



'Zetex plc. Fields New Road, Chadderton, Oldham, OL9-8NP, United Kingdom. Telephone: (44)161 622 4422 (Sales), (44)161 622 4444 (General Enquiries) Fax: (44)161 622 4420

Zetex GmbH Streitfeldstraße 19 D-81673 München Germany Telefon: (49) 89 45 49 49 0

Fax: (49) 89 45 49 49 49

Zetex Inc. 47 Mall Drive, Unit 4 Commack NY 11725 USA

Telephone: (631) 543-7100 Fax: (631) 864-7630

Zetex (Asia) Ltd. 3701-04 Metroplaza, Tower 1 Hing Fong Road, Kwai Fong, Hong Kong Telephone:(852) 26100 611

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Fax: (852) 24250 494

